

FGA6560WDF

April 2015

Features

- Maximum Junction Temperature : T_J =175°C
- · Positive Temperaure Co-efficient for Easy Parallel Operating

650 V, 60 A Field Stop Trench IGBT

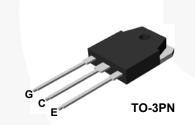
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} =1.8 V(Typ.) @ I_C = 60 A
- 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- · Fast Switching
- RoHS Compliant

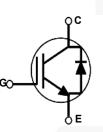
General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for welder and industrial applications where low conduction and switching losses are essential.

Applications

- Welder and Industrial Application
- Power Factor Correction





Absolute Maximum Ratings

Symbol	Description		FGA6560WDF	Unit
V _{CES}	Collector to Emitter Voltage		650	V
N/	Gate to Emitter Voltage		± 20	V
V _{GES}	Transient Gate to Emitter Voltage		± 30	V
I _C	Collector Current	@ T _C = 25 ^o C	120	А
'C	Collector Current	@ T _C = 100°C	60	А
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	180	А
I _{CM (2)}	Pulsed Collector Current		180	А
IF	Diode Forward Current	@ T _C = 25°C	60	А
۱ ⊢	Diode Forward Current	@ T _C = 100 ^o C	30	А
I _{FM (2)}	Pulsed Diode Maximum Forward Curren	t	120	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	306	W
. D	Maximum Power Dissipation	@ T _C = 100 ^o C	153	W
TJ	Operating Junction Temperature	-55 to +175	°C	
T _{stg}	Storage Temperature Range	-55 to +175	°C	
Τ _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C	

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_C =180 A, R_G = 62 $\Omega,$ Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	FGA6560WDF	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.49	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.75	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA6560WDF	FGA6560WDF	TO-3PN	Tube	-	-	30

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 1 mA	650	-	-	V
ΔBV _{CES} / ΔT _J	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.6	-	V/ºC
ICES	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 60 mA, V _{CE} = V _{GE}	4.1	5.6	7.6	V
		I _C = 60 A, V _{GE} = 15 V	-	1.8	2.3	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 60 A, V _{GE} = 15 V, T _C = 175°C	-	2.3	-	V
Dynamic C	Characteristics					-
C _{ies}	Input Capacitance		-	2419	-	pF
C _{oes}	Output Capacitance	V _{CE} = 30 V _, V _{GE} = 0 V, f = 1MHz	-	82	-	pF
C _{res}	Reverse Transfer Capacitance		-	31	-	pF
Switching	Characteristics	•			•	
t _{d(on)}	Turn-On Delay Time		-	25.6	-	ns
t _r	Rise Time		-	67.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 60 A,	-	71	-	ns
t _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	22	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	2.46	/ · -	mJ
E _{off}	Turn-Off Switching Loss		-	0.52	-	mJ
E _{ts}	Total Switching Loss]	-	2.98	-	mJ
t _{d(on)}	Turn-On Delay Time		-	22.4	- \	ns
t _r	Rise Time]	-	63.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 60 A,	-	77	-	ns
t _f	Fall Time	$R_{G} = 6 \Omega, V_{GF} = 15 V,$	-	22	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 175°C	-	3.19	-	mJ
		1		0.74		
E _{off}	Turn-Off Switching Loss		-	0.71	-	mJ

Electrical Characteristics of the IGBT (Continued)

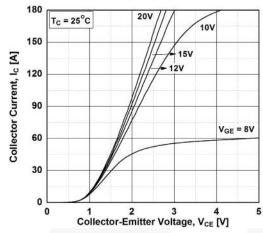
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge		-	84	-	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	15	-	nC
Q _{gc}	Gate to Collector Charge	VGE - 10 V	-	32	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions		Min.	Тур.	Мах	Unit	
V _{FM}	Diode Forward Voltage	I_ =	30 A		T _C = 25°C	-	1.8	2.3	V
* F M			50 A	-	T _C = 175°C	-	1.7	-	
E _{rec}	Reverse Recovery Energy				T _C = 175 ^o C		233	-	uJ
t	Diode Reverse Recovery Time		30 A, dI _F /dt = 200 A/µs	•	T _C = 25°C		110	-	ns
l ⁴ rr			η – 30 Α, αιμαι – 200 Α(μο	ŀ	T _C = 175°C	-	271	-	
Q _{rr}	Diode Reverse Recovery Charge			-	T _C = 25°C	-	400	-	nC
SIL	blodd Hoveldo Hodovory charge				T _C = 175 ^o C	-	1740	-	

Typical Performance Characteristics







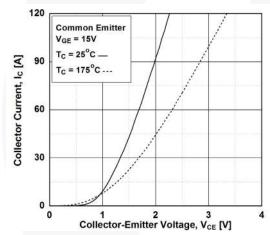


Figure 5. Saturation Voltage vs. V_{GE}

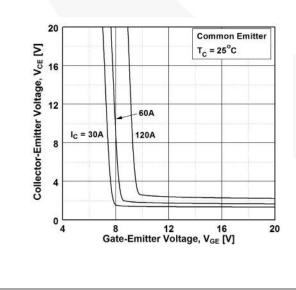
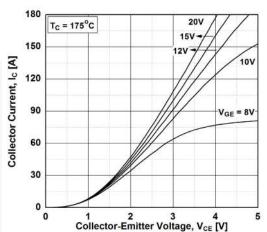
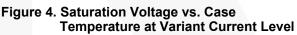


Figure 2. Typical Output Characteristics





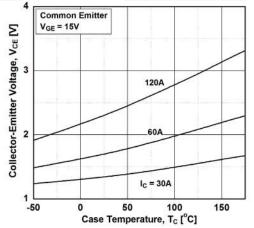
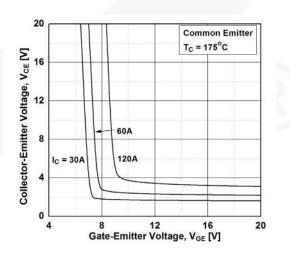


Figure 6. Saturation Voltage vs. V_{GE}



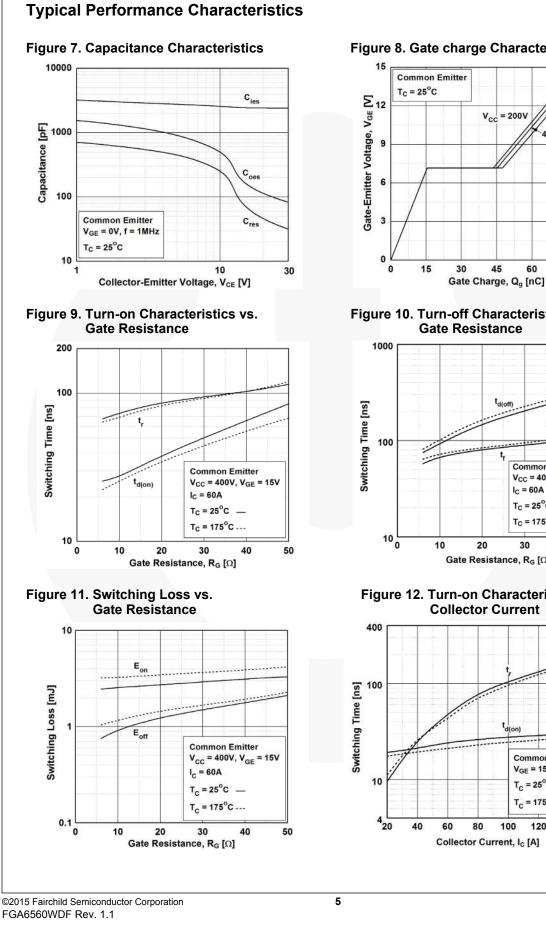


Figure 8. Gate charge Characteristics

300V

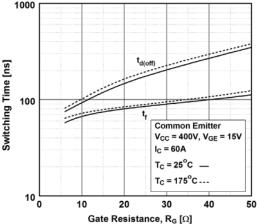
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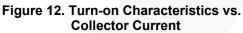
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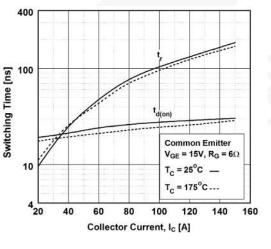
400V

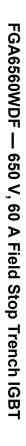
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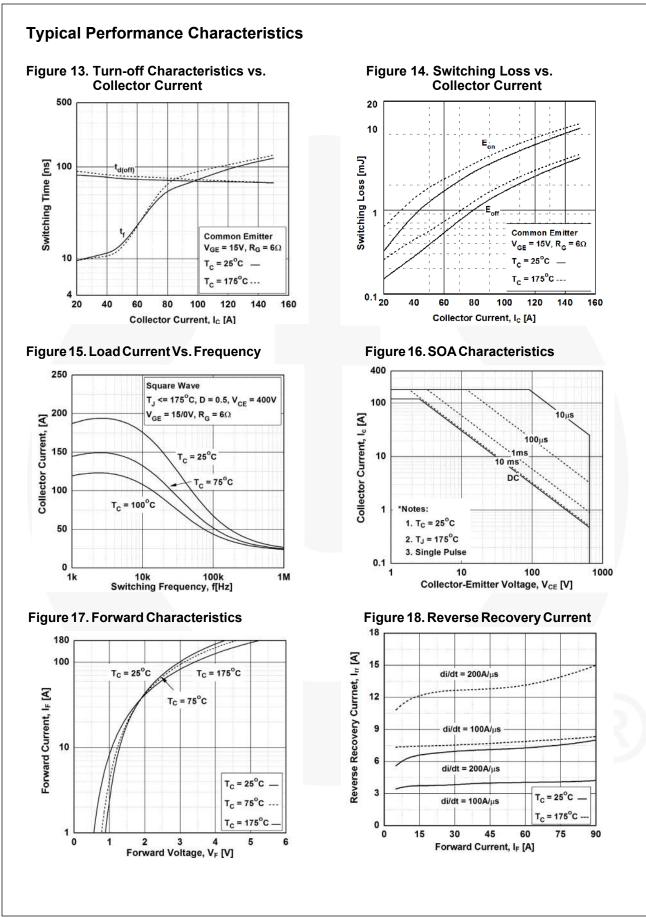


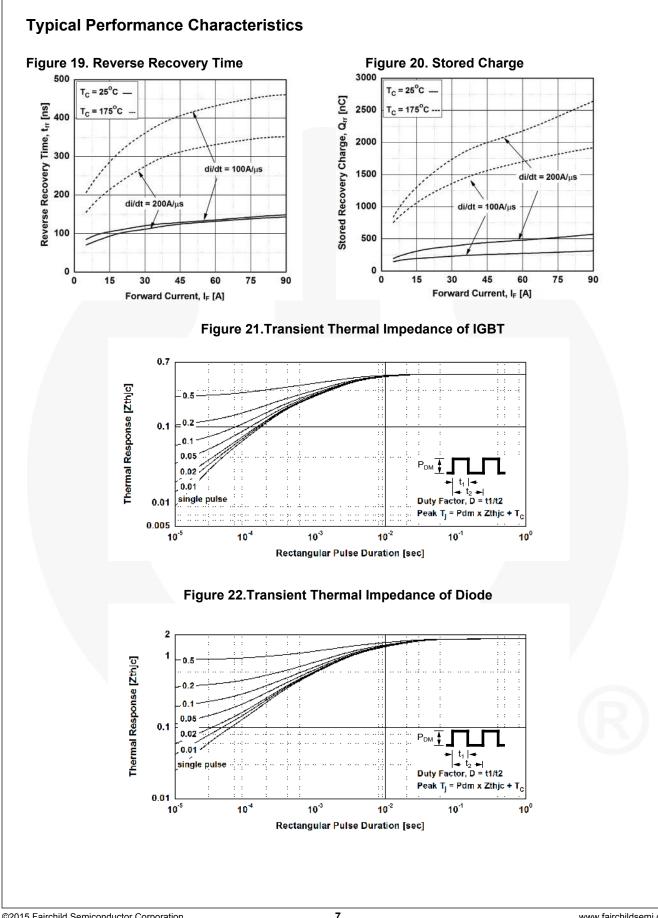


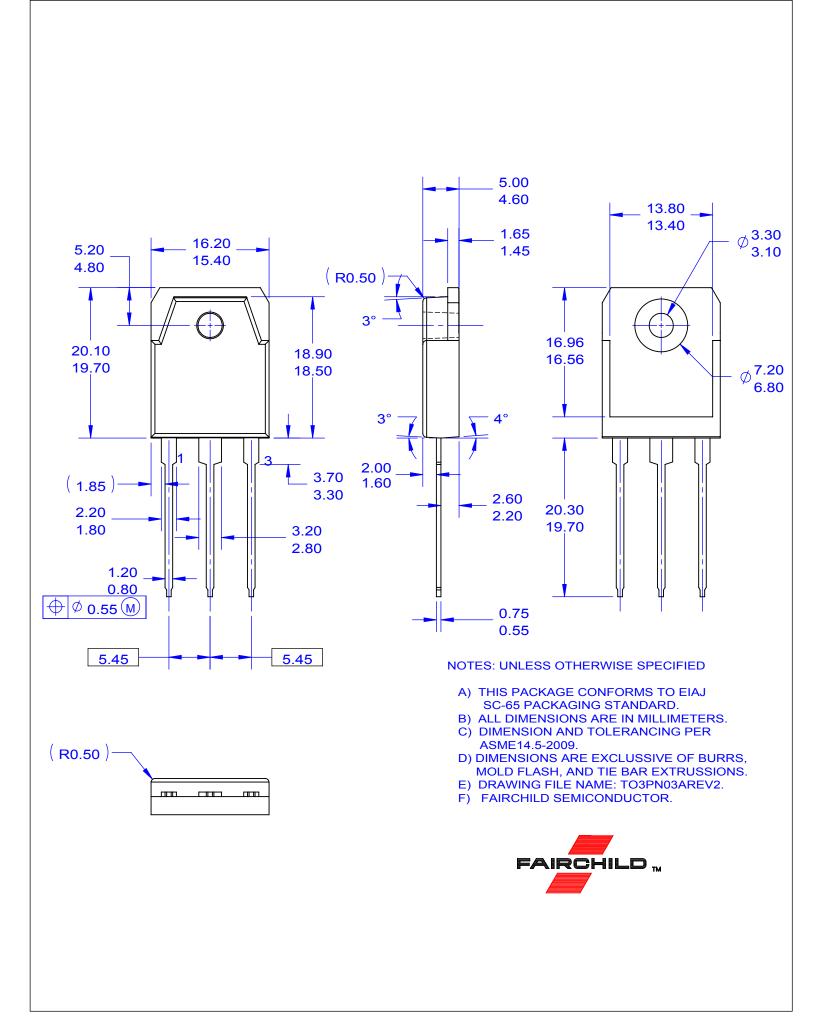


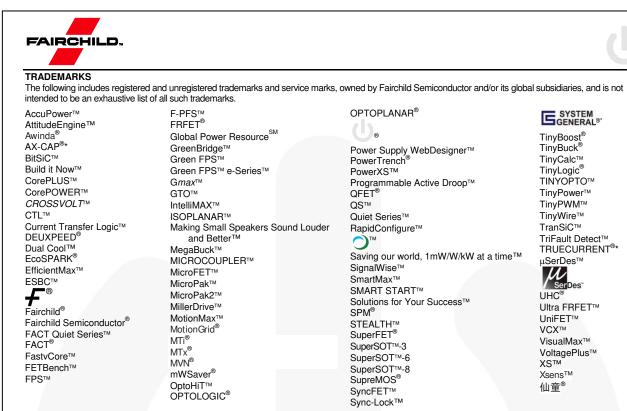












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Rev. 177